# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
KAILASH K. PATALAY	06/06/2008
CRAIG METZNER	06/18/2008
DAVID K. CARLSON	06/05/2008

## **RECEIVING PARTY DATA**

Name:	APPLIED MATERIALS, INC.	
Street Address:	P.O. BOX 450A	
Internal Address:	LEGAL AFFAIRS DEPT.	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95052	

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12144485

### **CORRESPONDENCE DATA**

Fax Number: (408)986-3090

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Correspondent Name: Robert W. Mulcahy
Address Line 1: P.O. BOX 450A

Address Line 2: LEGAL AFFAIRS DEPT.

Address Line 4: SANTA CLARA, CALIFORNIA 95052

ATTORNEY DOCKET NUMBER: AM12070/FEP/PJT

NAME OF SUBMITTER: ROBERT W MULCAHY

Total Attachments: 4

PATENT REEL: 021137 FRAME: 0356

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> PATENT REEL: 021137 FRAME: 0357

### ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

Kailash K. Patalay	Craig Metzner
500 Mansion Court, Apt. 304	618 Saddleback Terrace
Santa Clara, CA 95054	Fremont, CA 94536
USA	USA
David K. Carlson 4054 Claitor Way San Jose, CA 95132 USA	

(Hereinafter referred to as Assignors), have invented a certain invention entitled:

"Semiconductor Process Chamber Vision and Monitoring System"

for which application for Letters Patent in the United States was filed on \_\_\_\_\_

under Serial No., executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, CA 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of

PATENT REEL: 021137 FRAME: 0358

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any of said Patents.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	JUNE 6, 2008 , 2007, K	(INVENTOR) Karitash K. Patalay
2)	, 2007	(INVENTOR) Craig Metzner
3)	JUNE 5, 2008, 2007	(INVENTOR) David K. Carlson

### ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

50   Sa	ailash K. Patalay 00 Mansion Court, Apt. 304 anta Clara, CA 95054 SA	∦.	Craig Metzner 4142 Eagle Flight Dr Simi Valley , CA 93065
40 Sa	avid K. Carlson 054 Claitor Way an Jose, CA 95132 SA		

(Hereinafter referred to as Assignors), have invented a certain invention entitled:

"Semiconductor Process Chamber Vision and Monitoring System"

for which application for Letters Patent in the United States was filed on \_\_\_\_\_

under Serial No., executed on even date herewith; and

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PATENT REEL: 021137 FRAME: 0360 any of said Patents.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
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IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	, 2007	(INVENTOR) Kailash K. Patalay
2)	<u>6/18</u> , 2007	(INVENTOR)/Craig Metzner
3)	, 2007	(INVENTOR) David K. Carlson